# Darlington transistors with built-in temperature compensation diodes for audio amplifier applications



#### **Features**

- •Built-in temperature compensation diodes and one emitter resistor
- •Real time temperature compensation

The temperature compensation diodes are mounted on one chip and placed in the center of the chip to detect temperature rises directly.

•Elimination of the temperature dependency of the idling current

The temperature coefficient of the diodes is optimized to have the idling current stabilized; thus one of the fatal failure modes in conventional Darlington transistors, Thermal Runaway, is avoidable.

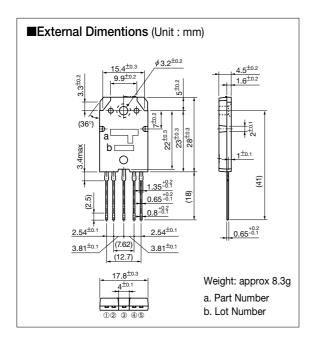
●Symmetrical design for the PNP and the NPN pinouts

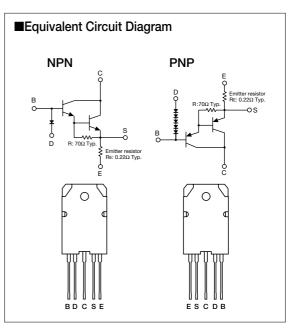
The new design minimizes the length of the pattern layout, and output distortions are controlled.

Darlington transistors, temperature compensation diodes and one emitter resistor are incorporated in one package, so labor for parts insertion as well as the parts count is reduced.

#### Line up

Part Number	Pc (W)	VCEO (V)	Ic (A)	h <sub>FE</sub>	Emitter resistor (Ω)
SAP15P/SAP15N	150	160	15	5000 to 20000	0.22
SAP10P/SAP10N	100	150	12	5000 to 20000	0.22
SAP08P/SAP08N	80	150	10	5000 to 20000	0.22





#### **■** Application Information

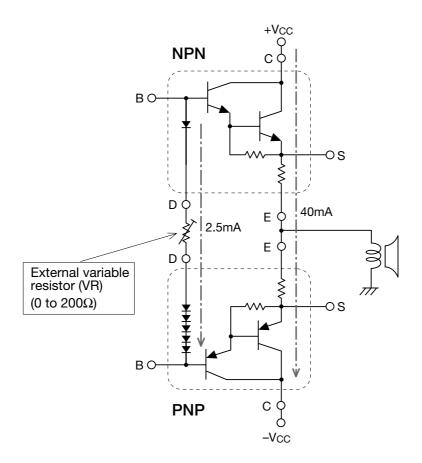
#### 1. Recommended Operating Conditions

- ①Add a variable resistor (VR) between diode terminals to adjust the idling current. The resistor having 0 to  $200\Omega$  is to be used.
- ②Adjust the forward current flowing over the diodes at 2.5mA.
- 3 Adjust the idling current at 40mA with the external variable resistor.

Both the temperature coefficients for the transistor and the diodes are matched under the above conditions. Both the PNP and the NPN are Darlington transistors, so the temperature change ratio of the total four VBE of the transistors is subject to the compensation. One PN junction diode in the NPN and five Schottky barrier diodes in the PNP are built-in, and the total six diodes are operating as the temperature compensation.

The temperature coefficient of the total diodes (its variable value) becomes smaller with a larger forward current (approximately  $-0.2 \text{mV}/^{\circ}\text{C}$  to 1 mA), and the coefficient of the total transistors (its variable value) also becomes smaller with a larger idling current (approximately  $-0.1 \text{mV}/^{\circ}\text{C}$  to 10 mA), but the both variable values are small.

Thus, the distortion of the temperature coefficient caused by the different current is small, so the thermal runaway may not be occurred due to the changes of the recommended ratings; however, the actual operation is to be confirmed by using an experimental equipment or board.



#### 2. External Variable Resistor

Total forward voltage (at  $I_F = 2.5 \text{mA}$ ) of the diodes is designed to be equal or less than that of total  $V_{BE}$  (at  $I_C = 40 \text{mA}$ ) of the transistor, thus the idling current is required to be adjusted at 40 mA with an additional external variable resistor.

The relations are shown as below:

### Total V<sub>F</sub> of Diode $\leq$ Total V<sub>BE</sub> of Transistor + Total V<sub>RE</sub> of Emitter Resistor $\Delta$ V=0 to 500mV

The  $V_{BE}$  of the transistor is dependent to the  $h_{FE}$ , and the  $V_{BE}$  is lower with higher  $h_{FE}$  and vice versa. The  $h_{FE}$  for both the PNP and the NPN varies between 5k and 20k; thus the  $V_{BE}$  is the lowest with the combination of maximum  $h_{FE}$  (20k) each and it is the highest with the combination of minimum  $h_{FE}$  (5k) each.

Presuming the voltage difference between the  $V_F$  of the diodes and the  $V_{BE}$  of the transistors (including the total voltage drops of the two emitter resistors) as  $\Delta V$ .

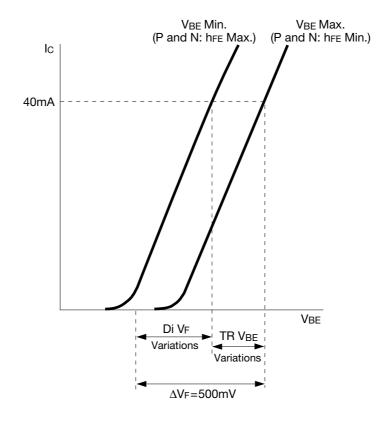
Minimum V<sub>BE</sub> – Maximum V<sub>F</sub> variations of the diodes = 0

Maximum V<sub>BE</sub> – Minimum V<sub>F</sub> variations of the diodes = 500mV

The current flowing over the diodes and the VR is adjusted at 2.5mA; therefore

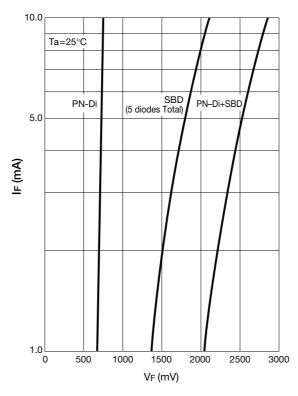
500mV  $\div 2.5$ mA = 200Ω

Consequently, the applicable VR value is to be 0 to  $200\Omega$ 



#### 3. Characteristics of the temperature compensation diodes

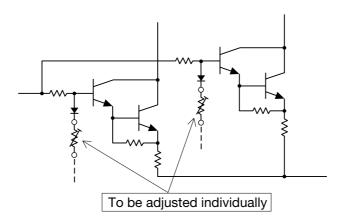
The several temperature compensation diodes are connected in series, so the forward voltage is varied with small current fluctuations. Therefore, in case the forward current flowing over the diodes is set at 2.5mA and over, the forward voltage rises, and in the worst combinations, the idling current reaches to 40mA and over with minimum VR of  $0\Omega$ . On the contrary, in case the forward current is set at 2.5mA or below, the idling current may not reach to 40mA with maximum VR of  $200\Omega$ .



IF-VF Characteristics

#### 4. Parallel push-pull application

Adjustments of the idling current are required by each the resistor in parallel push-pull applications. One side adjustment will cause the idling current to be unstable (seesaw operation) because of the different hfe.



#### 5. Destruction capacity of the built-in emitter resistor

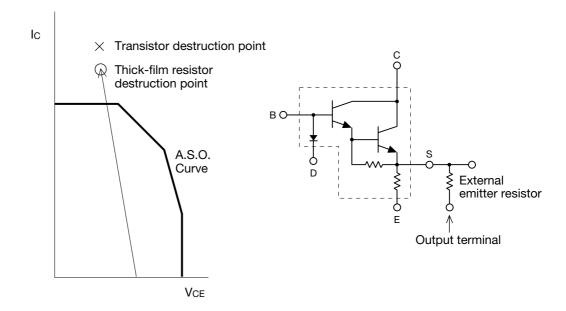
The built-in resistor is fabricated with polysilicone on the chip for the SAP08P/N and a thick-film resistor is used for the SAP10P/N and SAP15P/N. The latter, the thick-film resistor, has weaker destruction point in the Pc area (especially for large current flowing area) rather than that of the transistor chip itself. This is subject to the area beyond Safe Operating Area (S.O.A).

However, under the evaluation like a short circuit test in which the current exceeds the guaranteed value, it may cause the emitter resistor to be destroyed before the transistor itself is destroyed.

Consequently, the current value (or time) that operates the protection circuit is to be set at lower than that of discrete device configurations. In the application of car audio amplifiers, the same manners as the above need to be considered because the large current is flowed at low impedance.

In addition, once the transistor falls into thermal runaway due to a soldering failure to the external VR added between diodes or other failure manners, as the worst case, there may cause a resin crack or smoke emissions by flare up. Flame retardant molding resin is used, and the material of the product is conformed to the most sever standard UL94V0. However it is recommended that the careful consideration be given to a protection circuit, and the protection circuits should be provided appropriately in due course.

If the operating conditions are not to be matched to the ratings, it is also recommended that the E (Emitter resistor) terminal should be opened and the external emitter resistor should be added to the S (Sensing) terminal shown as below. (However this is not applicable to the SAP08P/N because a thin inner lead is used for S terminal.)



## **Built-in temperature compensation diodes Darlington**

Unit

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Α

Α

W

mΑ

٥С

°C

Symbol

**I**EBO

VCEO

h<sub>FE</sub>\*

V<sub>CE(sat)</sub>

V<sub>BE(sat)</sub>

Di V<sub>F</sub>

# compensation diodes Built-in emitter resistor Berlington



**Application:** Audio

Weight: Approx 8.3g

a. Part Number b. Lot Number

(Complement to type SAP10N)

Absolute maximum ratings (Ta=25°C)

Ratings

-150

-150

-5

-12

100 (Tc=25°C)

150

-55 to +150

Symbol

 $V_{CBO}$ 

VCEO

VEBO

lc

 $I_{\mathsf{B}}$ 

Рс

Di IF

Tstg

Τj

■Electrical Characteristics

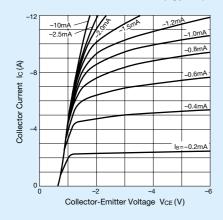
(Ta	=25°C)

cai Characteristics (1a					
Conditions		Unit			
Conditions	min	typ	max	Offic	
$V_{CB}=-150V$			-100	μΑ	
V <sub>EB</sub> =-5V			-100	μΑ	
Ic=-30mA	-150			٧	
V <sub>CE</sub> =-4V, I <sub>C</sub> =-7A	5000		20000		
I <sub>C</sub> =-7A, I <sub>B</sub> =-7mA			-2.0	٧	
I <sub>C</sub> =-7A, I <sub>B</sub> =-7mA			-2.5	V	
V <sub>CE</sub> =-20V, I <sub>C</sub> =-40mA		1210		mV	
I <sub>F</sub> =2.5mA		1540		mV	
I <sub>E</sub> =1A	0.176	0.22	0.264	Ω	

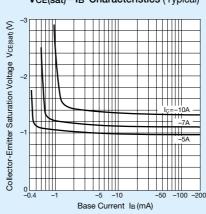
\*Rank O (5000 to 12000), Y (8000 to 20000)

**External Dimensions** (Unit: mm)

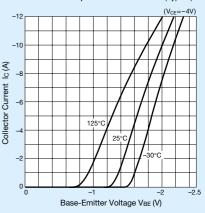
#### Ic-Vce Characteristics (Typical)



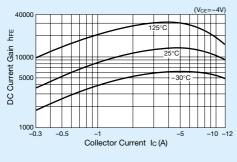
VcE(sat) - IB Characteristics (Typical)



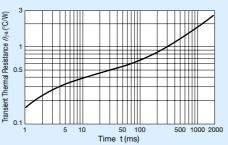
IC - VBE Temperature Characteristics (Typical)



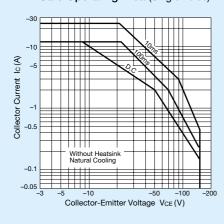
hfe-Ic Characteristics (Typical)



 $\theta_{i-a}$ -t Characteristics



Safe Operating Area (Single Pulse)



Pc-Ta Derating

